

MOSFET

OptiMOS[™] 5 Linear FET, 150 V

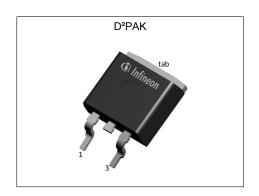
Features

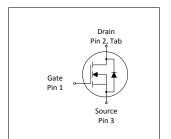
- Ideal for hot-swap and e-fuse applications
- Very low on-resistance R_{DS(on)}
 Wide safe operating area SOA
 N-channel, normal level

- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target applications
 Halogen-free according to IEC61249-2-21



Parameter	Value	Unit					
V _{DS}	150	V					
R _{DS(on),max}	4.8	mΩ					
I_{D}	150	A					
$I_{\text{pulse}} \ (V_{\text{DS}} = 56 \text{ V}, t_{\text{p}} = 10 \text{ ms})$	10.8	A					











Type / Ordering Code	Package	Marking	Related Links
IPB048N15N5LF	PG-TO263-3	048N15LF	_

OptiMOS[™] 5 Linear FET, 150 V



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1 Maximum ratings at $T_{\rm C}$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatar	0	Values				Nata / Tank Operativities	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current ¹⁾	I _D	- - -	-	150 115 18	A	V_{GS} =10 V, T_{C} =25 °C V_{GS} =10 V, T_{C} =100 °C V_{GS} =10 V, T_{C} =25 °C, R_{thJA} =40K/W ²⁾	
Pulsed drain current ³⁾	I _{D,pulse}	-	-	600	Α	T _C =25 °C	
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	30	mJ	I_D =40 A, R_{GS} =25 Ω	
Gate source voltage	V _{GS}	-20	-	20	V	-	
Power dissipation	P _{tot}	-	-	313	W	T _C =25 °C	
Operating and storage temperature T_{j} , T_{stg}		-55	-	150	°C	-	

2 Thermal characteristics

Table 3 Thermal characteristics

Devementar	Complete	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.25	0.4	K/W	-
Device on PCB, minimal footprint	R _{thJA}	-	-	62	K/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	-	-	40	K/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danish at an	0	Values					
Parameter	Symbol	Min.			Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	3.3	4.1	4.9	V	V _{DS} =V _{GS} , I _D =255 μA	
Zero gate voltage drain current	I _{DSS}	-	1 10	2 100	μA	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	2 -2	5 -5	μΑ	V _{GS} =20 V, V _{DS} =0 V V _{GS} =-10 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	3.9	4.8	mΩ	V _{GS} =10 V, I _D =100 A	
Gate resistance ¹⁾	R _G	-	25	38	Ω	-	
Transconductance ¹⁾	g fs	17	34	-	S	$ V_{DS} > 2 I_D R_{DS(on)max}, I_D = 100 A$	

Table 5 **Dynamic characteristics**

Davamatar	Cymphol	Values			1114	Note (Total Constitution	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance ¹⁾	C _{iss}	-	290	380	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	1400	1800	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	13	23	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	-	8	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	48	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	
Turn-off delay time	$t_{\sf d(off)}$	-	42	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t _f	-	10	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A, $R_{\rm G,ext}$ =1.6 Ω	

Gate charge characteristics²⁾ Table 6

Darameter	Symbol	Values		Unit	Note / Test Condition	
Parameter	Syllibol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Gate to source charge	Q _{gs}	-	2	-	nC	V_{DD} =75 V, I_{D} =60 A, V_{GS} =0 to 10 V
Gate to drain charge	Q _{gd}	-	56	-	nC	V_{DD} =75 V, I_{D} =60 A, V_{GS} =0 to 10 V
Gate charge total	Qg	-	84	-	nC	V _{DD} =75 V, I _D =60 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	7	-	V	V _{DD} =75 V, I _D =60 A, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	211	280	nC	V _{DD} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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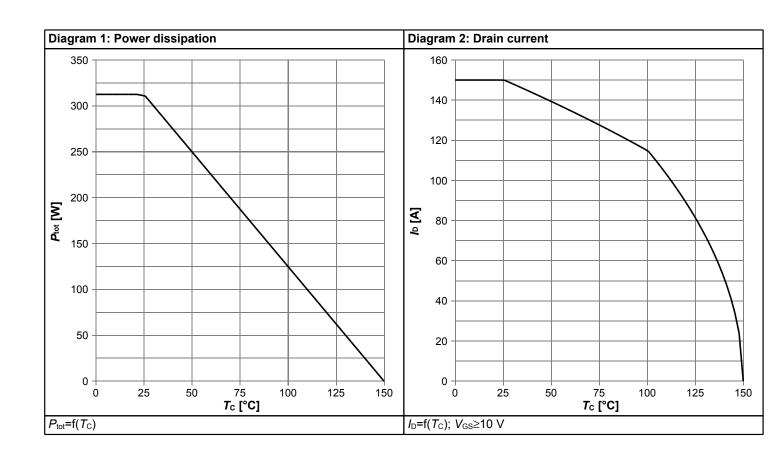


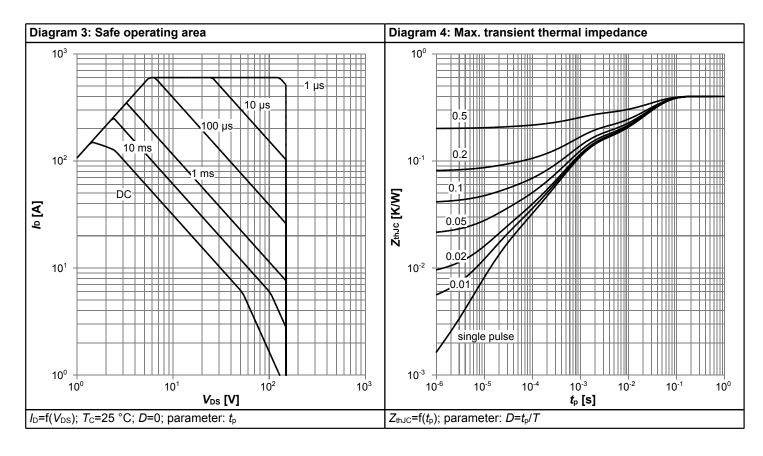
Table 7 Reverse diode

Davamatau	Cymphal		Values			Nets / Test Ossalition
Parameter	Symbol	Min. Typ. Max.		Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	150	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	600	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.93	1.2	V	V _{GS} =0 V, I _F =100 A, T _j =25 °C
Reverse recovery time	<i>t</i> _{rr}	-	60	-	ns	V_R =75 V, I_F =60 A, di_F/dt =100 A/ μ s
Reverse recovery charge	Qrr	-	81	-	nC	V_R =75 V, I_F =60 A, di_F/dt =100 A/ μ s

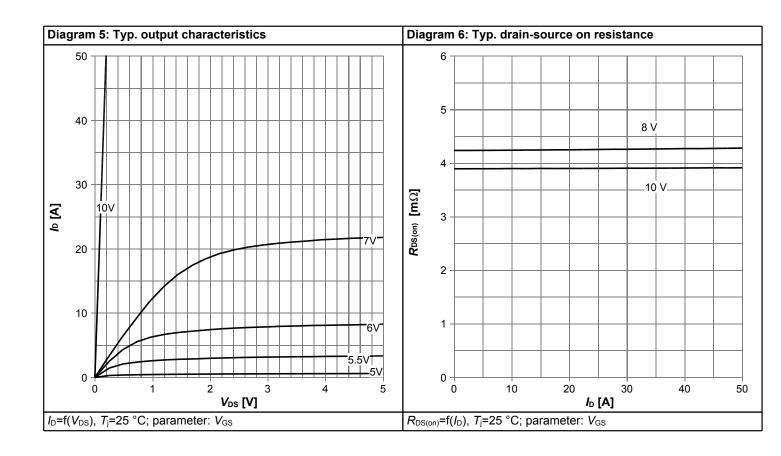


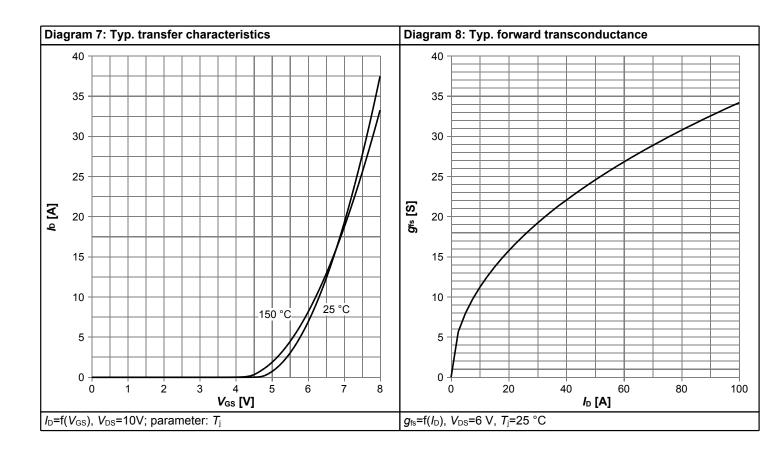
4 Electrical characteristics diagrams



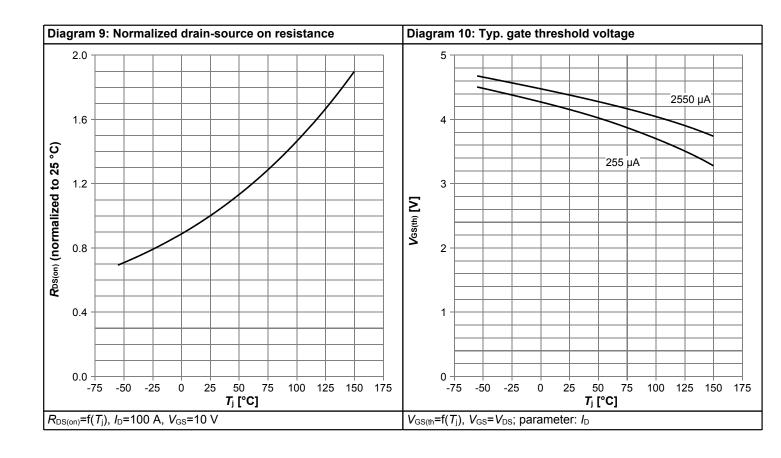


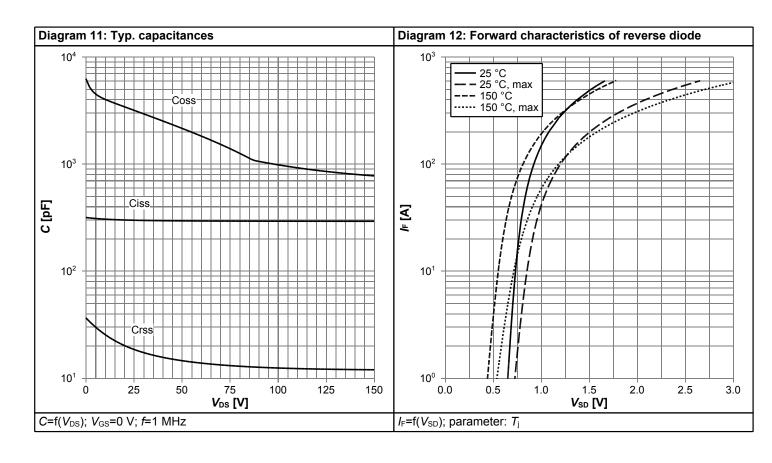




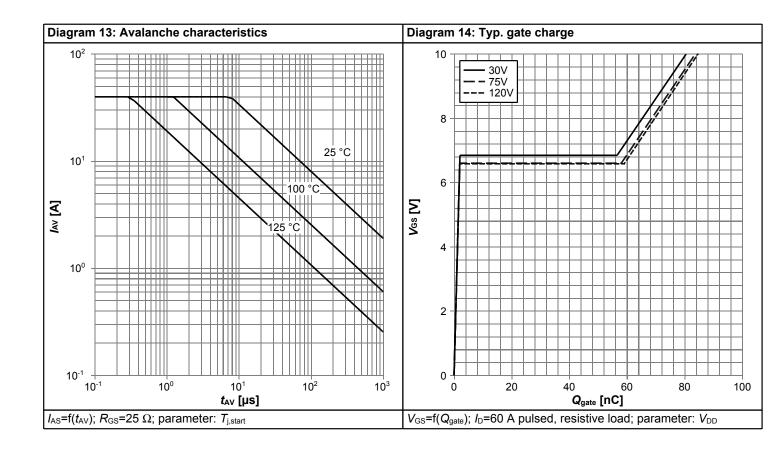


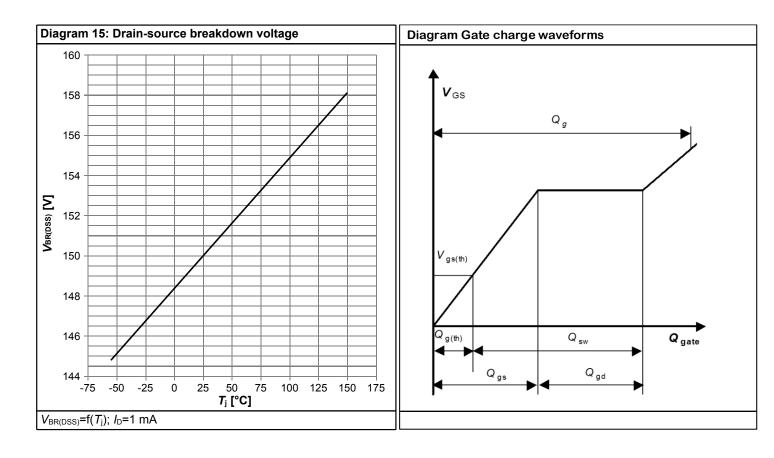






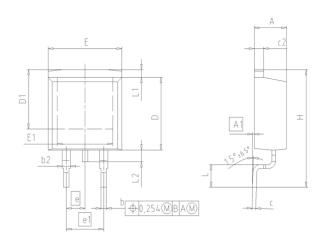


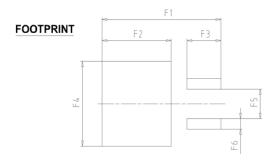






5 Package Outlines





DIM	MILLIN	ETERS	INCH	INCHES		
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.57	0.169	0.180		
A1	0.00	0.25	0.000	0.010		
b	0.65	0.85	0.026	0.033		
b2	0.95	1.15	0.037	0.045		
С	0.33	0.65	0.013	0.026		
c2	1.17	1.40	0.046	0.055		
D	8.51	9.45	0.335	0.372		
D1	7.10	7.90	0.280	0.311		
E	9.80	10.31	0.386	0.406		
E1	6.50	8.60	0.256	0.339		
е	2.5	54	0.100			
e1	5.0	08	0.200			
N		2	2			
Н	14.61	15.88	0.575	0.625		
L	2.29	3.00	0.090	0.118		
L1	0.70	1.60	0.028	0.063		
L2	1.00	1.78	0.039	0.070		
F1	16.05	16.25	0.632	0.640		
F2	9.30	9.50	0.366	0.374		
F3	4.50	4.70	0.177	0.185		
F4	10.70	10.90	0.421	0.429		
F5	3.65	3.85	0.144	0.152		
F6	1.25	1.45	0.049	0.057		

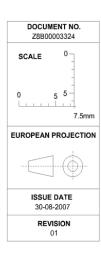


Figure 1 Outline PG-TO263-3, dimensions in mm/inches

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Revision History

IPB048N15N5LF

Revision: 2022-09-09, Rev. 2.2

Previous Revision

FIEVIOUS	CENISION	
Revision	Date	Subjects (major changes since last revision)
2.0	2017-03-29	Release of final version
2.1	2022-06-23	Update current rating, footnotes and skip condition "Operating and storage temperature".
2.2	2022-09-09	Update legend Diagram 7

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